

FN990B40 Drawing / location and Label Sample

Rev.2 2024-07-05

Rev.2

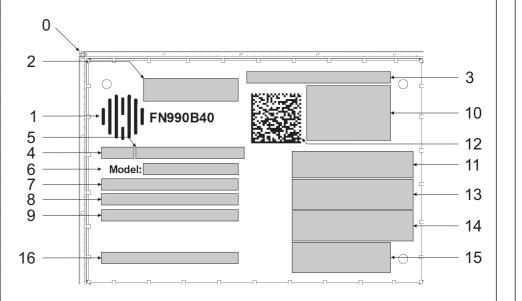
LAYOUT DESCRIPTION 1) Place of the **Telit Cinterion Logo** (5,5x6mm) (File TC_Logo.bmp). Offset between (ref.0) point (shield edges) and object upper left corner x=2mm y=4,7mm. 2) Clear writing of the text as reported on row 0005 of the Master BOM. Font Arial-Bold 5pt. Offset between (ref.0) point and object upper left corner x=8,2mm y=6,8mm. 3) Clear writing of the text as reported on row 0085 of the Master BOM. Font Arial-Bold 4pt. Offset between (ref.0) point and object upper left corner x=21,5mm y=2mm. 4) Clear writing of the text as reported on row 0080 of the Master BOM. Font Arial-Bold 4pt. Offset between (ref.0) point and object upper left corner x=3mm y=11,7mm. 5) Clear writing of module ID number as indicated on the P32-EN Product ID number allocation document. Font Arial-Bold 4pt. Offset between (ref.0) point and object upper left corner x=6,4mm y=11,7mm. 6) Clear writing of "Model: " followed by the text as reported on row 005 of the Master BOM. Font Arial-Bold 4pt. Offset between (ref.0) point and object upper left corner x=3mm y=13,7mm. 7) Clear writing of the text as reported on row 0015 of the Master BOM. Font Arial-Bold 4pt. Offset between (ref.0) point and object upper left corner x=3mm y=15,7mm. 8) Clear writing of the text as reported on row 0030 of the Master BOM. Font Arial-Bold 4pt. Offset between (ref.0) point and object upper left corner x=3mm y=17,6mm. 9) Clear writing of the text as reported on row 0035 of the Master BOM. Font Arial-Bold 4pt. Offset between (ref.0) point and object upper left corner x=3mm y=19,7mm. 10) Placement of the logo reported on row 0049 of Master BOM respecting the dimensions in brackets and oriented as in figure. Offset between (ref.0) point (shield edges) and object upper left corner x=30mm y=5,5mm. 11) Placement of the logo reported on row 0054 of the Master BOM respecting the dimensions in brackets and oriented as in figure. Offset between (ref.0) point (shield edges) and object upper left corner x=27,5mm y=12,5mm. 12) For IMEI only modules (as per P32-EN): Barcode type 2D datamatrix of ID+BSN string formatted as below: First 15 chars = ID module number (IMEI) as indicated on the P32-EN Product ID number allocation document. Next char = ID separator ";" Next chars = Value of the string as reported on row 0005 of 3990400xxx Module Part List. **Last 9 chars** = MM1234567 where MM = Contract Manufacturer ID number (2 digits with leading zeros) as reported on P32-EN ANNEX. 1234567 = Serial 7 digits progressive number including leading zeros. Example: 060000123 For IMEI+MACID modules (as per P32-EN): Barcode type 2D datamatrix of ID+BSN+MACID string formatted as below: First 15 chars = ID module number (IMEI) as indicated on the P32-EN Product ID number allocation document. Next char = ID separator ";" Next chars = Value of the string as reported on row 0005 of 3990400xxx Module Part List. **Next 9 chars** = MM1234567 where MM = Contract Manufacturer ID number (2 digits with leading zeros) as reported in P32-EN ANNEX. **1234567** = Serial 7 digits progressive number including leading zeros. Example: 060000123 Next char = ID separator ";" Last 17 chars = MACID number with separator ":" (AA:BB:CC:DD:EE:FF). Barcode type 2D datamatrix size 5 x 5 mm tolerance xy +/- 0.5mm Quite zone: 1,5mm Offset between (ref.0) point (shield edges) and barcode upper left corner x=21,5mm y=4,8mm tolerance xy +/- 0,5mm. 13) Placement of the logo reported on row 0076 of the Master BOM respecting the dimensions in brackets and oriented as in figure. Offset between (ref.0) point (shield edges) and object upper left corner x=27,5mm y=24mm. 14) Placement of the logo reported on row 0052 of Master BOM respecting the dimensions in brackets. Offset between (ref.0) point (shield edges) and object upper left corner x=27,5mm y=20mm. 15) Placement of the logo reported on row 0060 of the Master BOM respecting the dimensions in brackets and oriented as in figure. Offset between (ref.0) point (shield edges) and object upper left corner x=27,5mm y=16mm.

NOTE: If in Master BOM the lines to which reference is done on layout specification don't exist, the field on the label is not applicable and therefore must not be filled.

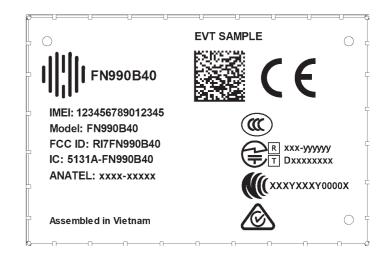
LAST CHANGE LOG

(16) Clear writing of "Assembled in " followed by the production country. Font Arial-Bold 4pt. Offset between (ref.0) point (shield edges) and object upper left corner x=3mm y=25,5mm.

Adjusted shield holes and offsets.

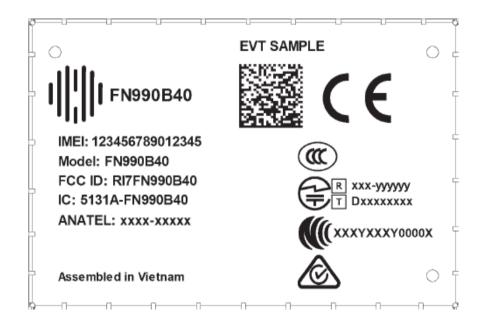


LABEL SAMPLE



FILE NAME: 2001702280.cdr		Telit Cinterion		DEVICE LABEL			
REV. :2							
Shield dimensions: 29,5x43,9 mm		ANNOTATION					FORM
		FN990B40 - LASER MARKED					A3
Drawn by: D. Gerl	2024-07-05			SHEET N.	OF SHEETS	DRAWING CODE	
				1	1	2001702280	

Label sample for FCC ID RI7FN990B40





Thank You!

Telit reserves all rights to this document and the information contained herein. Products, names, logos and designs described herein may in whole or in part be subject to intellectual property rights. The information contained herein is provided "as is." No warranty of any kind, either express or implied, is made in relation to the accuracy, reliability, fitness for a particular purpose or content of this document. This document may be revised by Telit at any time. For most recent documents, please visit www.telit.com © 2021-2022 Telit. All Rights Reserved.